Tool ID: 113 Tool Location: 103

### **Equipment Information Sheet**

# **Boron Doping - D1**

Manager: Phil Infante 607-254-4926 Backup: Aaron Windsor 607-254-4831

Calls to staff phones will be automatically forwarded to their cell phones during accessible hours. At other times

leave a message or send them an email.

#### **SAFETY**

• The furnaces are run at elevated temperatures of 400-1200°C and use flammable, toxic, and corrosive gases.

#### **USAGE RESTRICTIONS**

- No changing of gas flows or process parameters without staff approval
- Max process temperature of 1100 C

#### SCHEDULING/SIGN-UP RESTRICTIONS

Minimum Tool Time: 90 minutes

• Reservation blocks greater than 8 hrs must be cleared by a MOS staff person prior to reserving the time

#### MATERIALS COMPATIBILITY CATEGORY

Tool Category 1E: Silicon Based Materials and Select Dieletrics	
Allowed	Not Allowed
Silicon Based Materials only	No Evaporated or Sputtered Films
Si, SiC, SiO <sub>2</sub> substrates	No Metal or Organic Films
All Furnace grown or deposited films	No Glass Substrates
PECVD Films	No III/V Compound Semiconductors
Select ALD dieletrics (SiO <sub>2</sub> , SiN, HfO <sub>2</sub> , HFN)	No High Vapor pressure materials
Spin on Glass and Spin on Dopants	Organic/Biology Molecules prepared-with or without Salt buffers

High Vapor Pressure Metals and Compounds are materials that have a vapor pressure above 1e-6 Torr at 400 C.

## **Additional Material Restrictions and Exceptions**

• MOS CLEAN required prior to use

Last Updated: 08/06/2019